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Status	Product Specification
FAST Products	

FEATURES

- High impedance NPN base inputs for reduced loading (20 μ A in High and Low states)
- Low power, light loading
- Functional pin for pin equivalent of 'F244
- 1/30th the bus loading of 'F244
- Provides ideal interface and increase fan-out of MOS Microprocessors
- Octal bus interface
- 3-State buffer outputs sink 64mA and source 15mA

DESCRIPTION

The 74F1244 is an octal buffer that is ideal for driving bus lines or buffer memory address registers. The outputs are capable of sinking 64mA and sourcing up to 15mA, producing very good capacitive drive characteristics. The device features two Output Enables, $\overline{OE}_a$ and $\overline{OE}_b$, each controlling four of the 3-state outputs.

FAST 74F1244

Buffer

74F1244 Octal Buffer (3-State)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F1244	4.5ns	43mA

ORDERING INFORMATION

PACKAGES	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$; $T_A = 0^\circ C$ to $+70^\circ C$
20-Pin Plastic DIP	N74F1244N
20-Pin Plastic SOL	N74F1244D

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F(U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
I_{an}, I_{bn}	Data inputs	1.0/0.033	20 μ A/20 μ A
$\overline{OE}_a, \overline{OE}_b$	Output Enable inputs (active Low)	1.0/0.033	20 μ A/20 μ A
Y_{an}, Y_{bn}	Data outputs	750/106.7	15mA/64mA

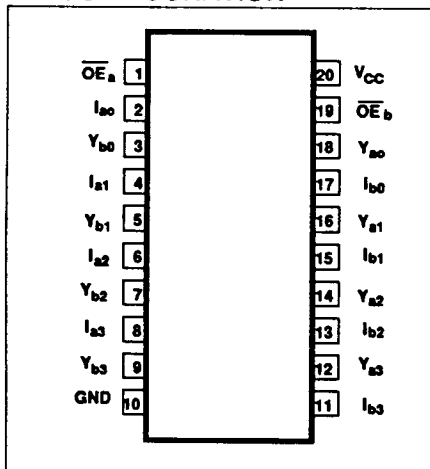
NOTE:

One (1.0) FAST Unit Load is defined as: 20 μ A in the High state and 0.6mA in the Low state.

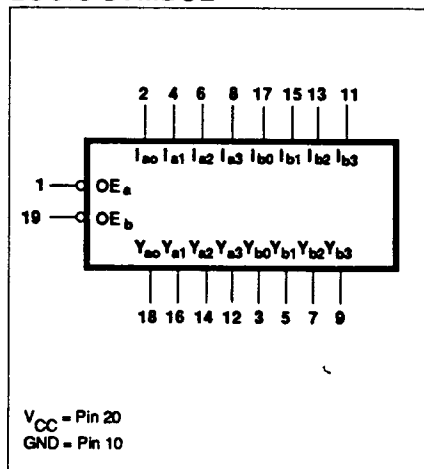
The 'F1244 is pin and functional compatible with the 'F244. The lower power and light bus loading features make it an ideal

part to interface directly with MOS Microprocessors.

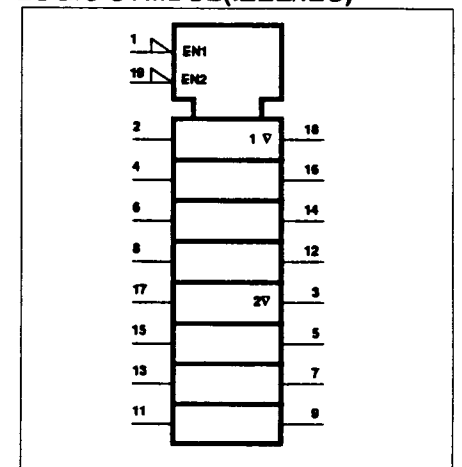
PIN CONFIGURATION



LOGIC SYMBOL



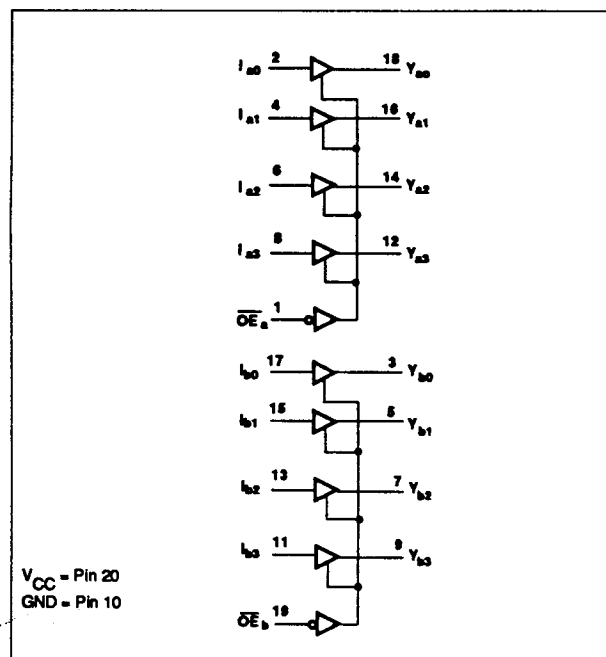
LOGIC SYMBOL (IEEE/IEC)



Buffer

FAST 74F1244

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS				OUTPUTS	
$\overline{OE}_A$	I_A	$\overline{OE}_B$	I_B	Y_A	Y_B
L	L	L	L	L	L
L	H	L	H	H	H
H	X	H	X	Z	Z

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V_{CC}	Supply voltage	-0.5 to +7.0	V
V_{IN}	Input voltage	-0.5 to +7.0	V
I_{IN}	Input current	-30 to +5	mA
V_{OUT}	Voltage applied to output in High output state	-0.5 to $+V_{CC}$	V
I_{OUT}	Current applied to output in Low output state	128	mA
T_A	Operating free-air temperature range	0 to +70	°C
T_{STG}	Storage temperature	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS			UNIT
		Min	Nom	Max	
V_{CC}	Supply voltage	4.5	5.0	5.5	V
V_{IH}	High-level input voltage	2.0			V
V_{IL}	Low-level input voltage			0.8	V
I_{IK}	Input clamp current			-18	mA
I_{OH}	High-level output current			-15	mA
I_{OL}	Low-level output current			64	mA
T_A	Operating free-air temperature range	0		70	°C

Buffer

FAST 74F1244

DC ELECTRICAL CHARACTERISTICS (Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER	TEST CONDITIONS ¹			LIMITS			UNIT
					Min	Typ ²	Max	
V_{OH}	High-level output voltage	$V_{CC} = \text{MIN},$ $V_{IL} = \text{MAX}$ $V_{IH} = \text{MIN},$	$I_{OH} = -3\text{mA}$	$\pm 10\% V_{CC}$	2.5			V
				$\pm 5\% V_{CC}$	2.7	3.4		V
			$I_{OH} = -15\text{mA}$	$\pm 10\% V_{CC}$	2.0			V
				$\pm 5\% V_{CC}$	2.0			V
V_{OL}	Low-level output voltage	$V_{CC} = \text{MIN},$ $V_{IL} = \text{MAX}$ $V_{IH} = \text{MIN},$	$I_{OL} = 48\text{mA}$	$\pm 10\% V_{CC}$		0.38	0.55	V
			$I_{OL} = 64\text{mA}$	$\pm 5\% V_{CC}$		0.42	0.55	V
V_{IK}	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = I_{IK}$				-0.73	-1.2	V
I_I	Input current at maximum input voltage	$V_{CC} = 0.0\text{V}, V_I = 7.0\text{V}$					100	μA
I_{IH}	High-level input current	$V_{CC} = \text{MAX}, V_I = 2.7\text{V}$					20	μA
I_{IL}	Low-level input current	$V_{CC} = \text{MAX}, V_I = 0.5\text{V}$					-20	μA
I_{OZH}	Off-state output current, High-level voltage applied	$V_{CC} = \text{MAX}, V_O = 2.7\text{V}$					50	μA
I_{OZL}	Off-state output current, Low-level voltage applied	$V_{CC} = \text{MAX}, V_O = 0.5\text{V}$					-50	μA
I_{OS}	Short-circuit output current ³	$V_{CC} = \text{MAX}$			-100		-225	mA
I_{CC}	Supply current (total)	I_{CCH}	$V_{CC} = \text{MAX}$			30	40	mA
		I_{CCL}				57	75	mA
		I_{CCZ}				43	58	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at $V_{CC} = 5\text{V}, T_A = 25^\circ\text{C}$.
- Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

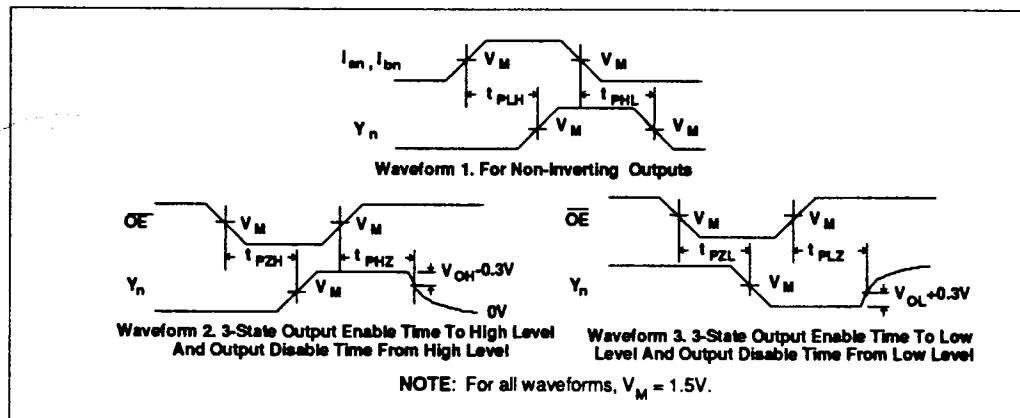
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FAST 74F1244

AC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITION	LIMITS						UNIT
			$T_A = +25^{\circ}\text{C}$ $V_{CC} = 5\text{V}$ $C_L = 50\text{pF}$ $R_L = 500\Omega$			$T_A = 0^{\circ}\text{C to } +70^{\circ}\text{C}$ $V_{CC} = 5\text{V} \pm 10\%$ $C_L = 50\text{pF}$ $R_L = 500\Omega$			
			Min	Typ	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation delay I_{an}, I_{bn} to Y_n	Waveform 1	2.5 2.0	4.0 5.0	5.5 7.0	2.5 2.0	6.0 7.5	ns ns	
t_{PZH} t_{PZL}	Output Enable time to High or Low level	Waveform 2 Waveform 3	3.0 3.0	6.0 6.5	7.5 8.0	3.0 3.0	8.5 8.5	ns ns	
t_{PHZ} t_{PLZ}	Output Disable time to High or Low level	Waveform 2 Waveform 3	2.0 2.0	4.0 4.0	5.5 5.5	2.0 2.0	6.0 6.0	ns ns	

AC WAVEFORMS



TEST CIRCUIT AND WAVEFORMS

